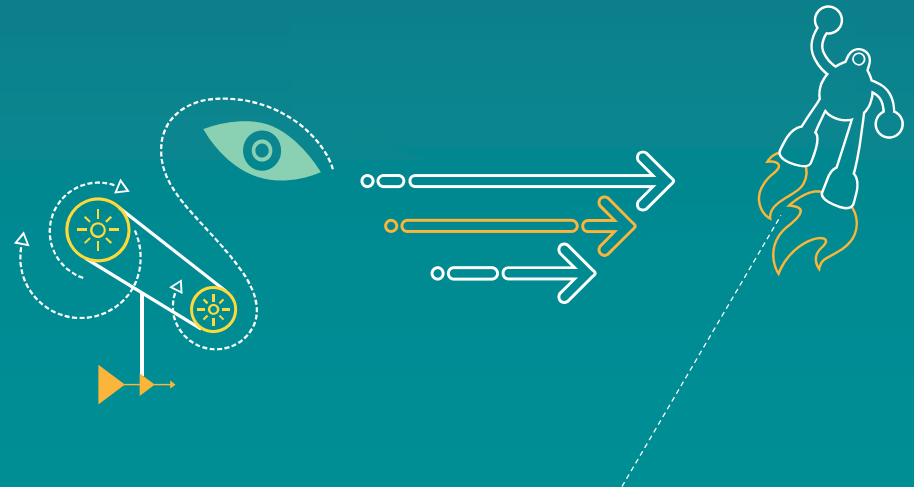


80-P7567-6 Rev. A



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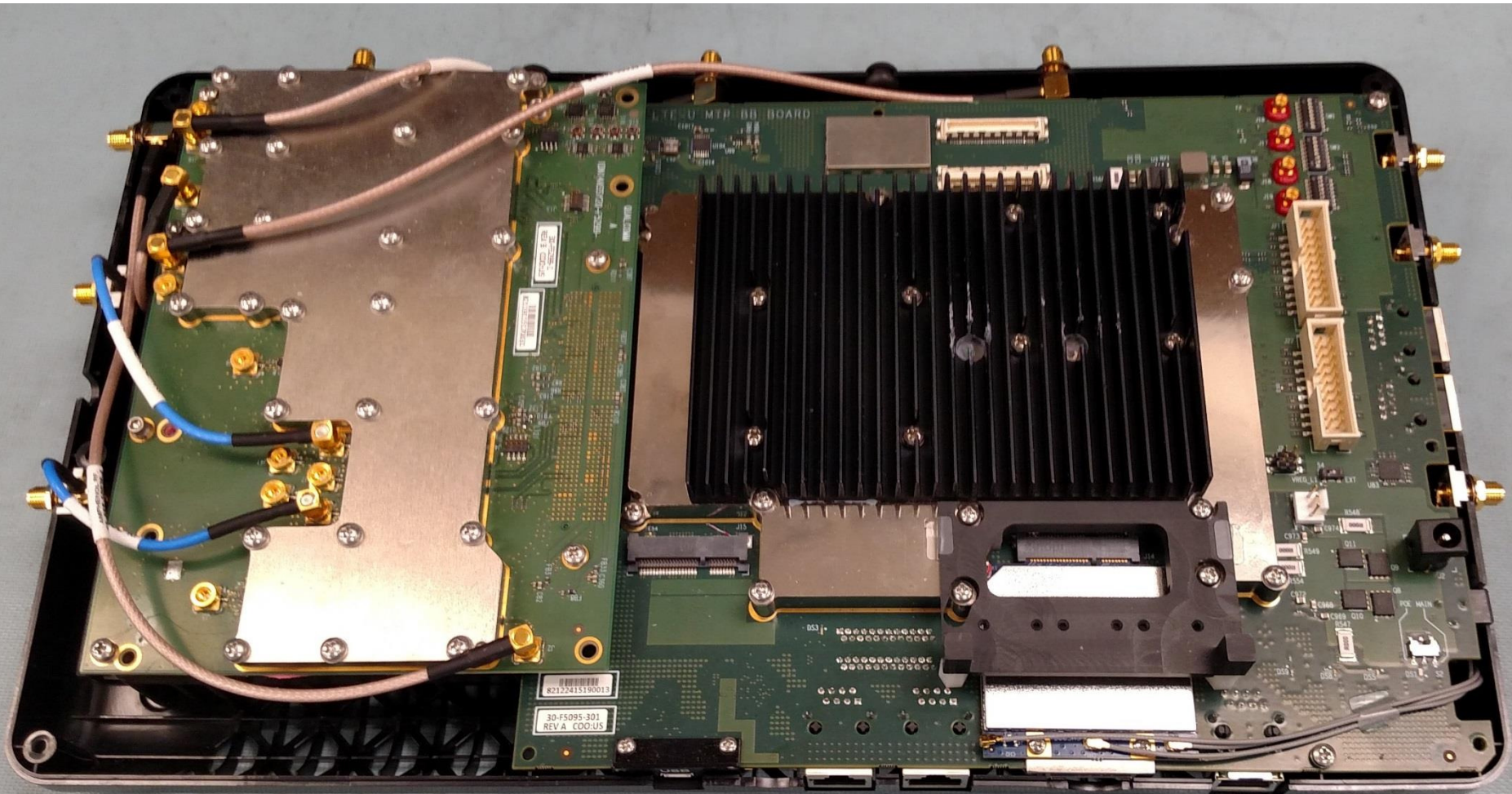
Qualcomm Technologies, Inc.
5775 Morehouse Drive
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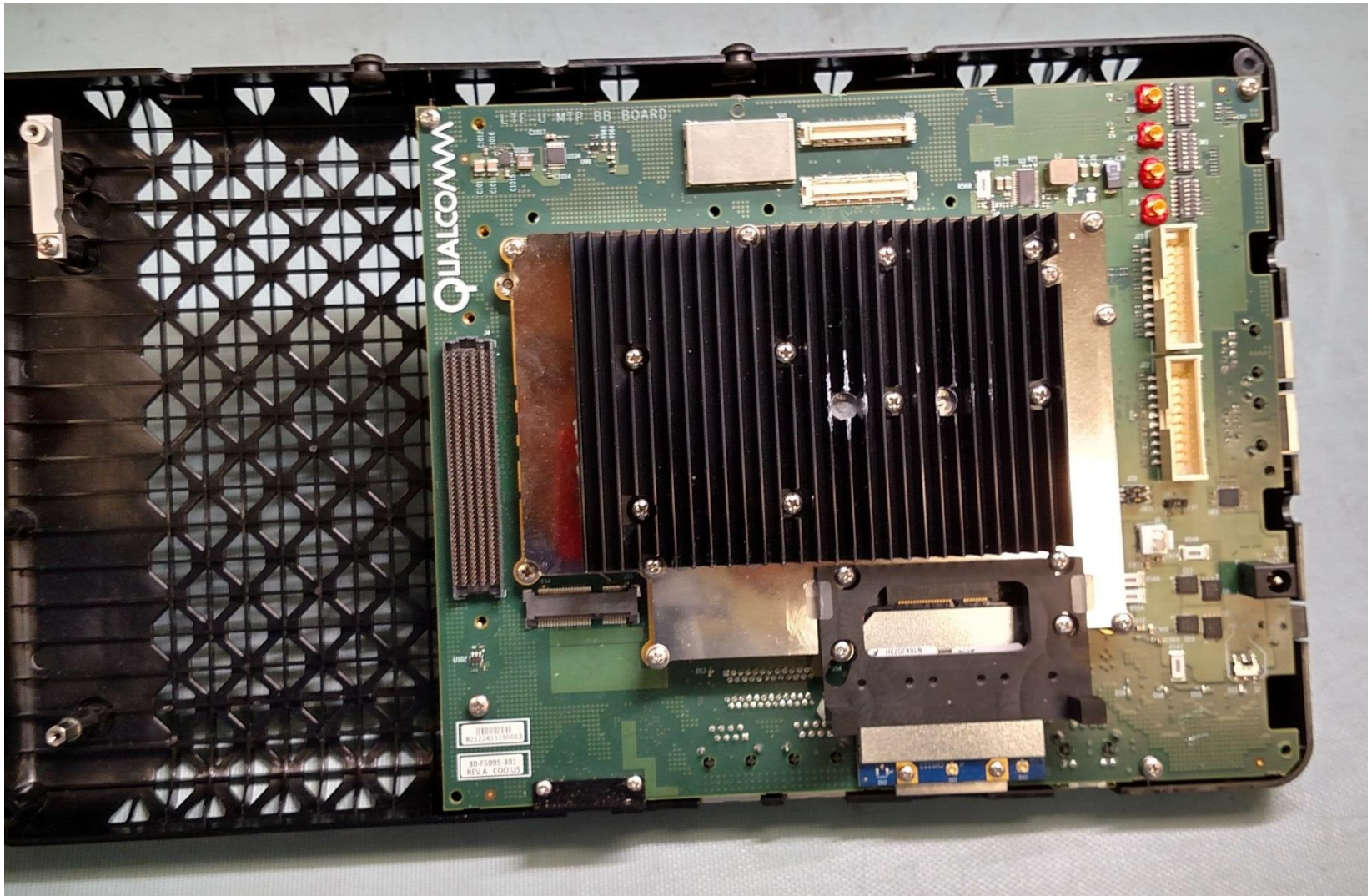
Revision History

Revision	Date	Description
A	July 2016	Initial release

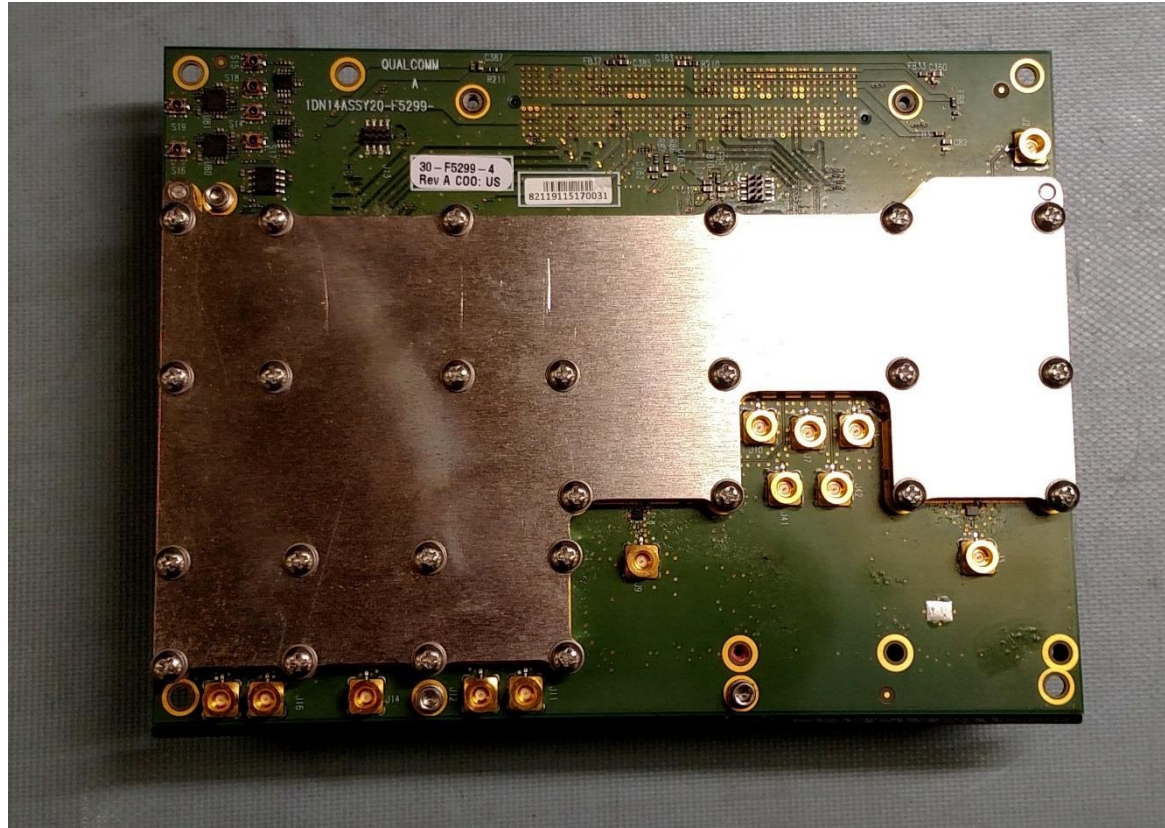
MTP9900 – Top Internal View



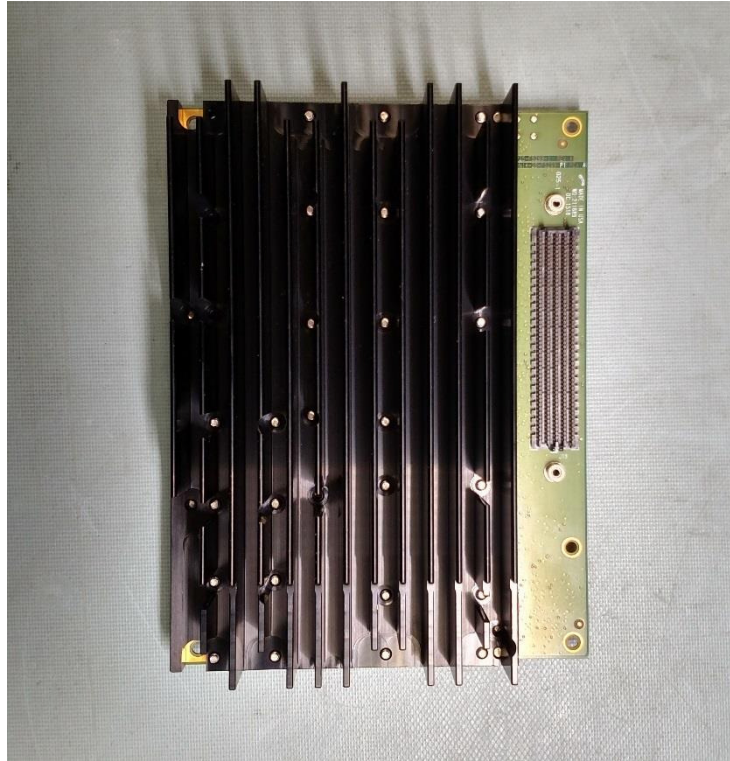
MTP9900 – Bottom Internal View



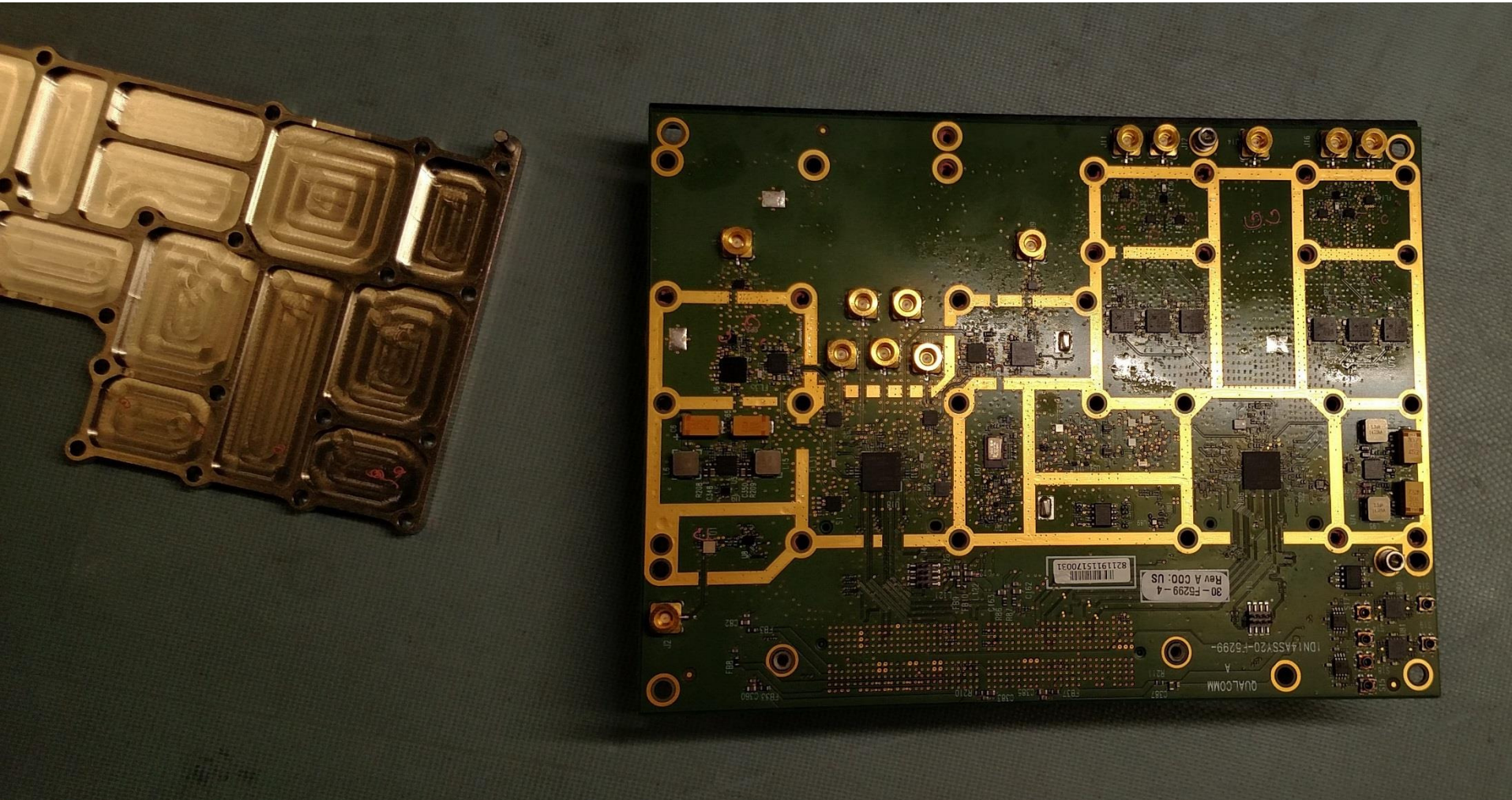
RF Card with Shield and Heatsink (1 of 2)



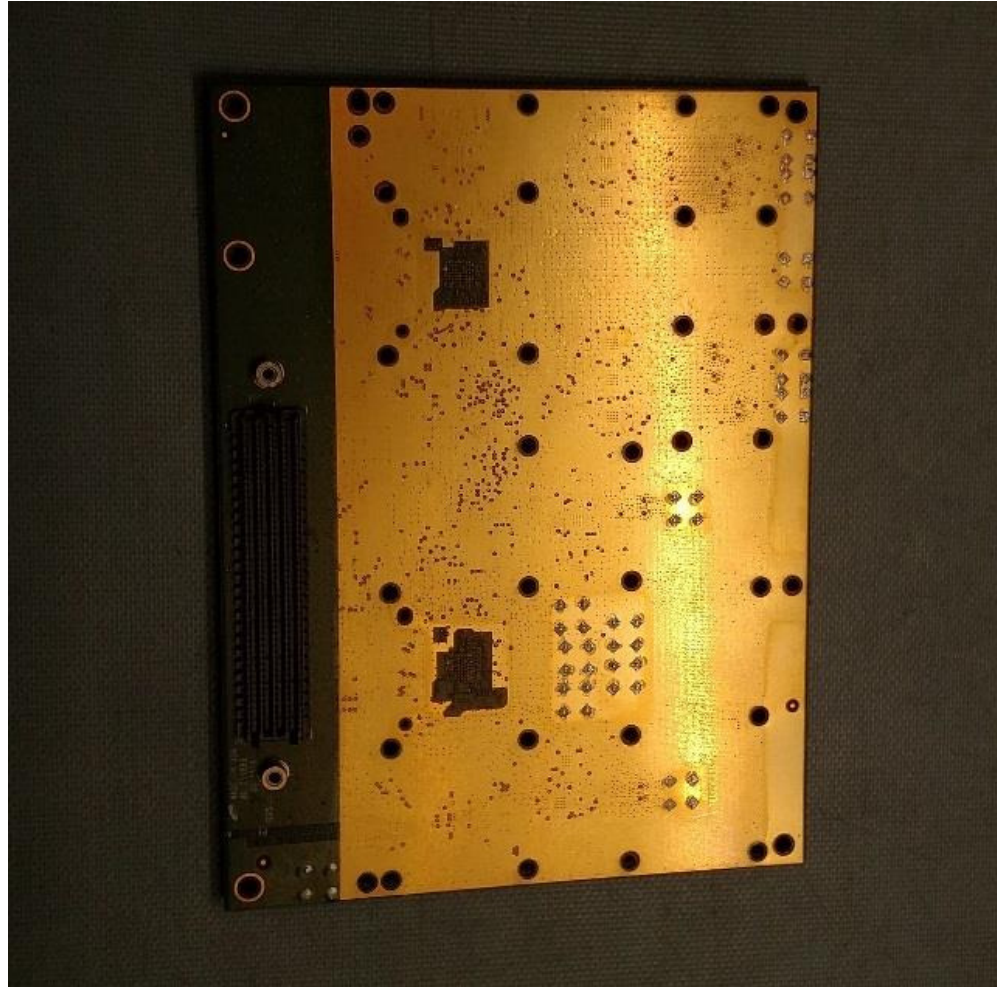
RF Card with Shield and Heatsink (2 of 2)



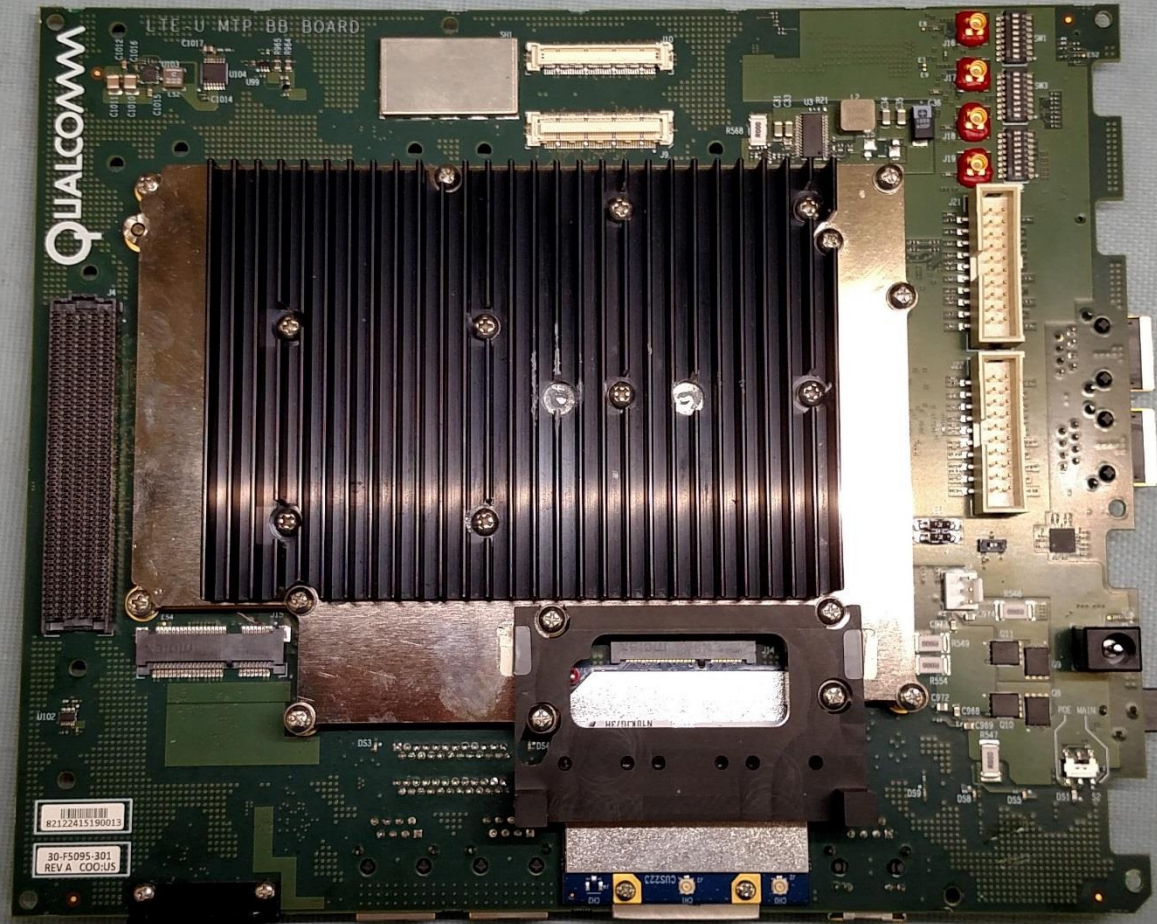
RF Board (1 of 2)



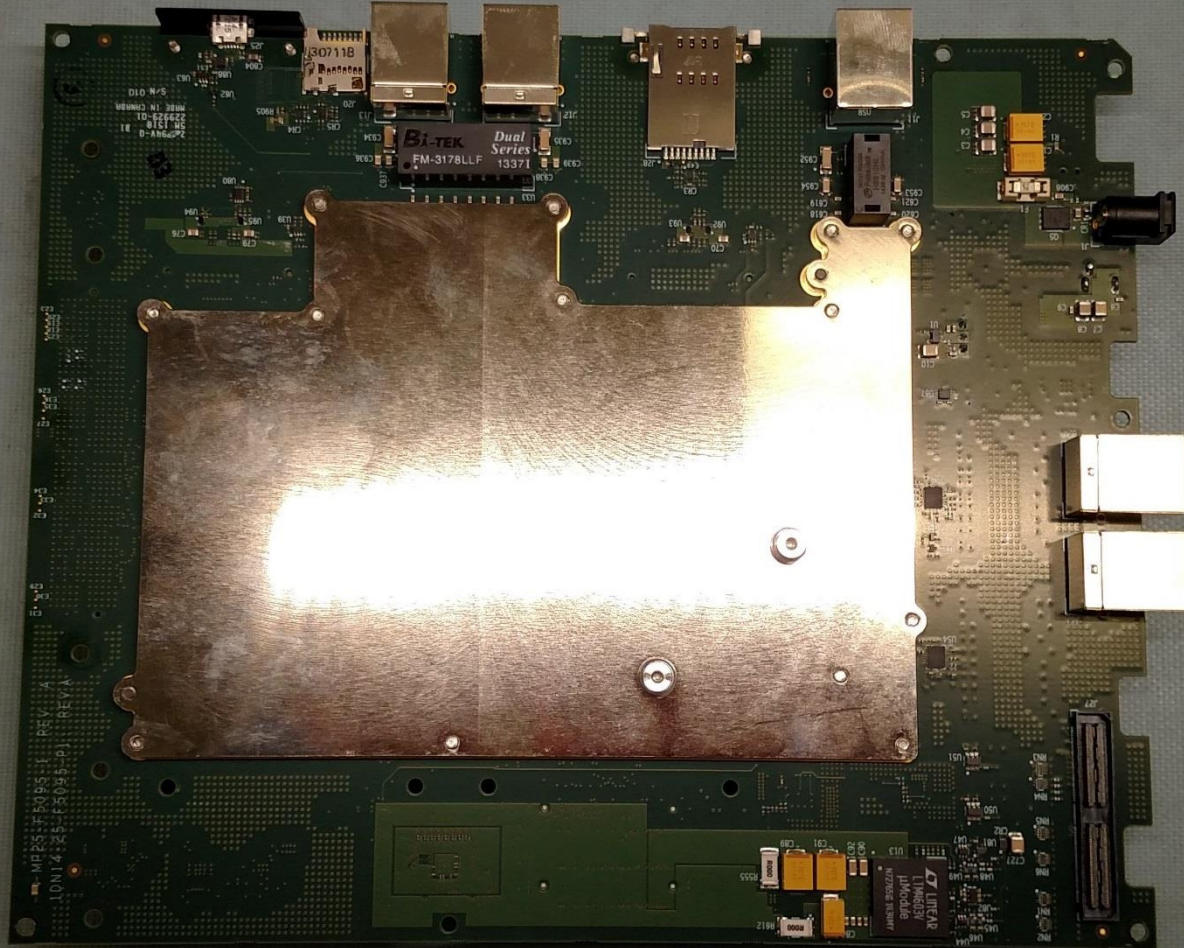
RF Board (2 of 2)



Baseband Board with Shield and Heatsink (1 of 2)



Baseband Board with Shield and Heatsink (2 of 2)



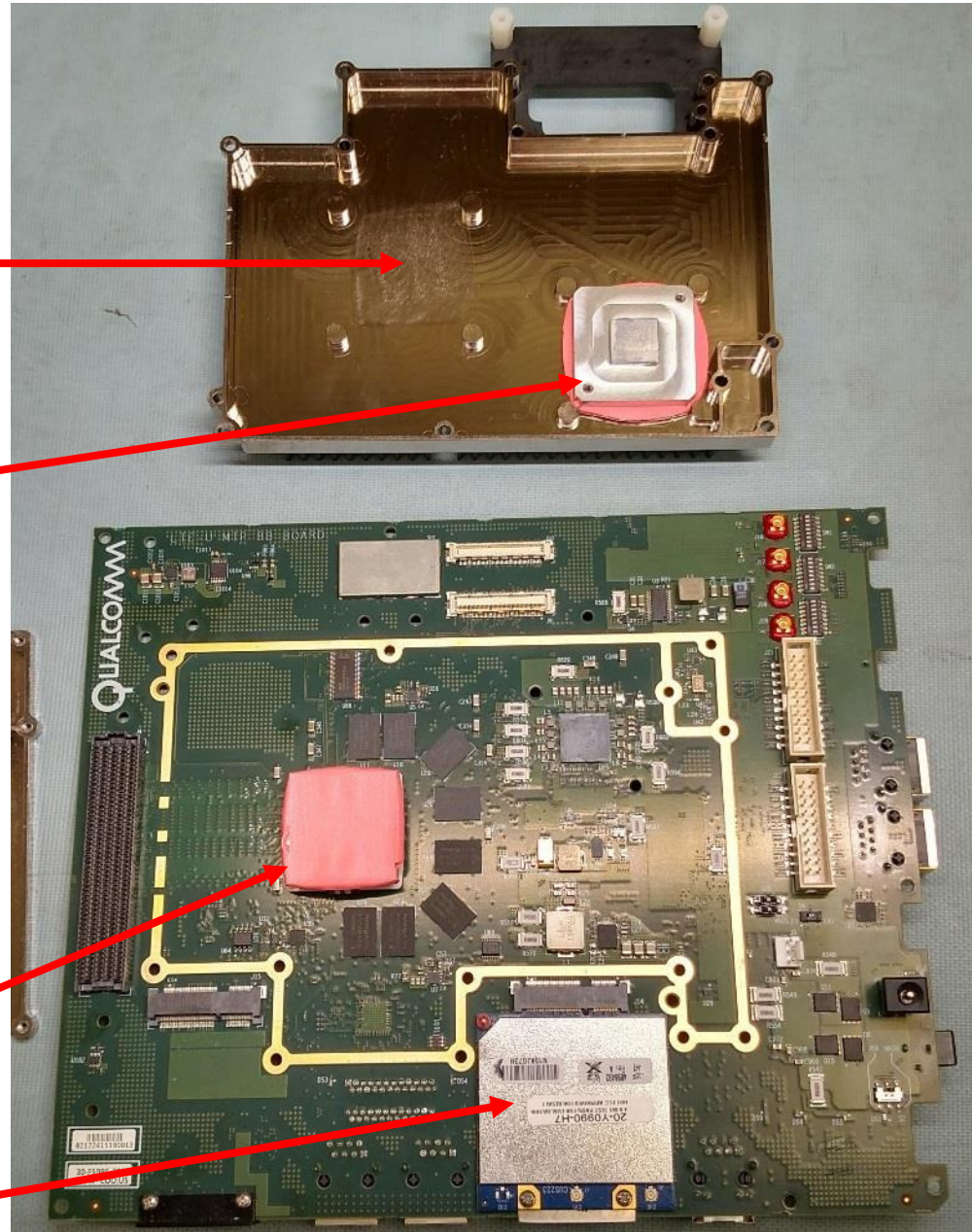
Baseband Board without Shield and Heatsink (1 of 2)

Top Shield

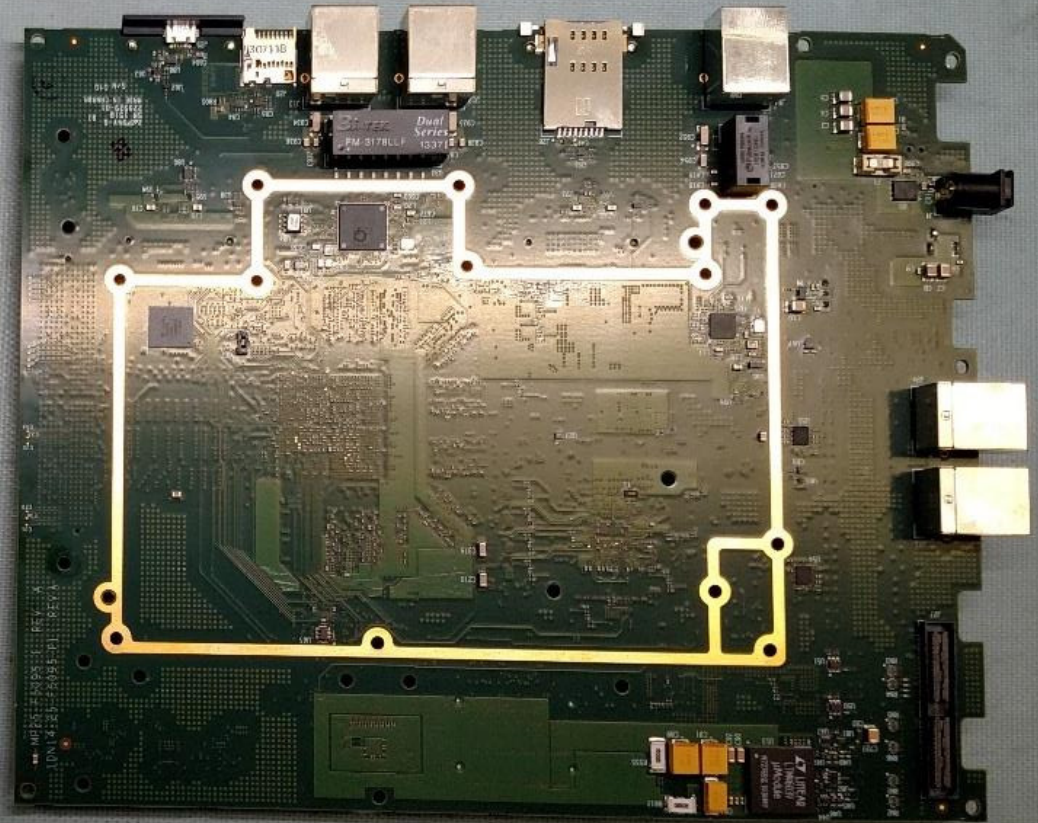
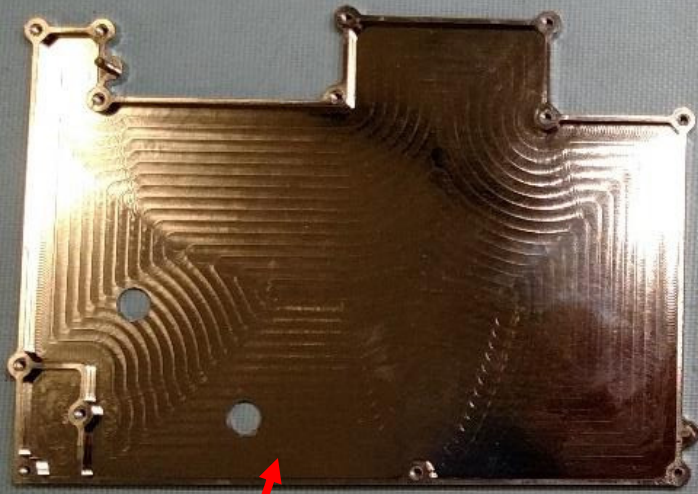
Heat Spreader and TIM

Heat Spreader and TIM

Wi-Fi Board

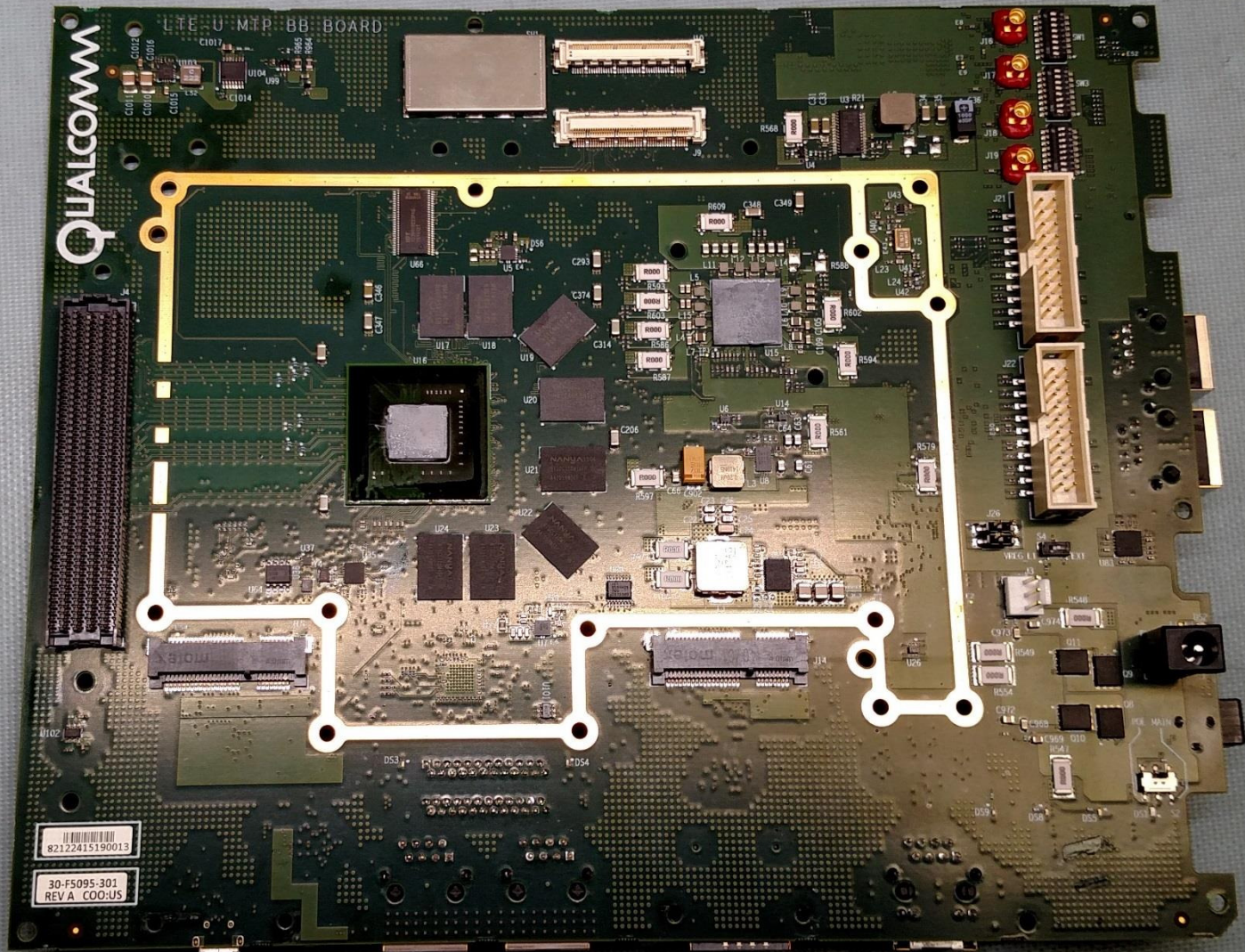


Baseband Board without Shield and Heatsink (2 of 2)



Bottom Shield

Baseband Board without Shield, Heatsink, Wi-Fi Board, or Heat Spreaders



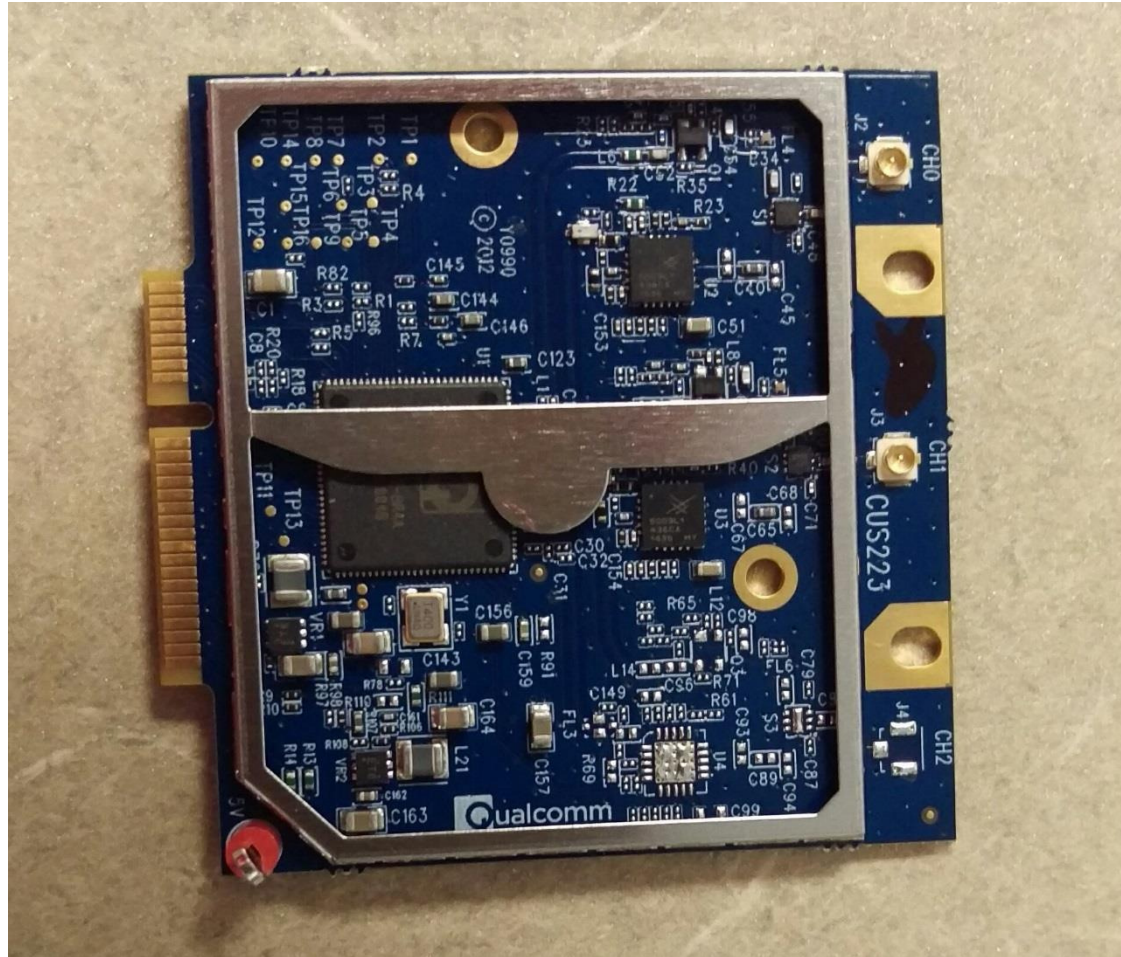
Wi-Fi Board (1 of 2)



Wi-Fi Board (2 of 2)



Wi-Fi Board – Internal



Thank You

